# **GSDS5014D4F**

# **Schottky Diode**

### **Product Description**

Schottky Barrier Diode 40V and 100mA

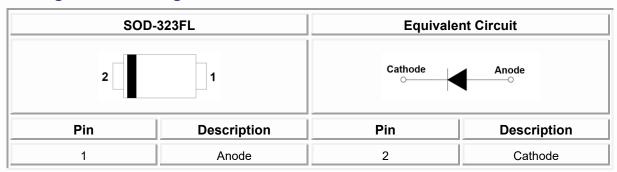
#### **Features**

Low Forward Voltage

#### **Mechanical Data**

- SOD-323FL. Package
- RoHS Compliant and Halogen Free

# **Package and Pin Assignment**



# **Ordering and Marking Information**

GS P/N	Package	Marking	Quantity / Reel
GSDS5014D4F	SOD-323FL	CF	3,000PCS
GSDS5014D4F - Product Code: GSDS5014	<del>_</del>	<ul> <li>Package Code:</li> <li>D4 for SOD-323FL</li> <li>F for RoHS Compliant and Halogen Free</li> </ul>	
	Marking	Information	
	- Product Code □□ is CF - Band denotes		



# Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise specified)

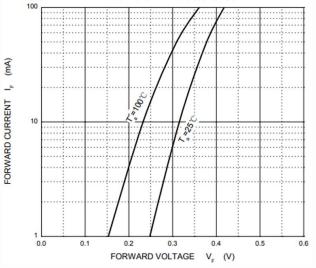
Symbol	Parameter	Value	Unit
$V_{RM}$	Reverse Voltage (repetitive peak)	45	V
VR	Reverse Voltage (DC)	40	V
lo	Forward Current	100	mA
IFSM	Non-Repetitive Peak Forward Current (8.3ms single half sin-wave)	1	Α
P <sub>D</sub>	Power Dissipation	200	mW
TJ	Junction Temperature	125	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +125	°C

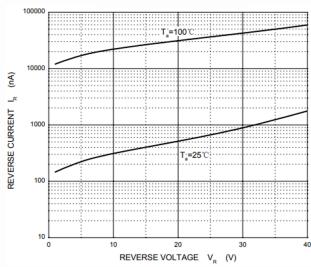
# Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
.,	Famous Maltana	I <sub>F</sub> =10mA			0.34		
V <sub>F</sub> Forward Voltage	I <sub>F</sub> =100mA			0.55	V		
IR	Reverse Current	V <sub>R</sub> =10V			30	μA	
Сл	Junction Capacitance	V <sub>R</sub> =10V, f=1MHz		5		pF	



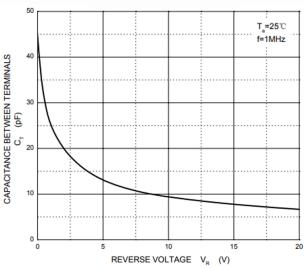
# Typical Characteristics ( $T_A$ =25 $^{\circ}$ C unless otherwise specified)





**FIG.1 Forward Characteristics** 

**FIG.2 Reverse Characteristics** 



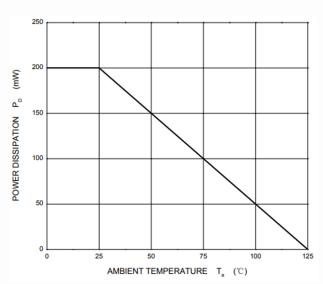


FIG.3 Capacitance

**FIG.4 Power Derating Curve** 

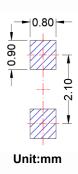


# SOD-323FL

# **Package Dimension**

# 

#### **Recommended Land Pattern**



	Dimensions				
Oh all	Millimeters		Inches		
Symbol	Min	Max	Min	Max	
Α	0.60	1.10	0.023	0.043	
b	0.25	0.60	0.010	0.024	
С	0.05	0.26	0.002	0.010	
D	1.15	1.35	0.045	0.053	
Е	2.30	2.70	0.091	0.106	
E1	1.60	1.80	0.063	0.071	
L	0.30	0.50	0.012	0.020	

#### NOTE:

Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



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